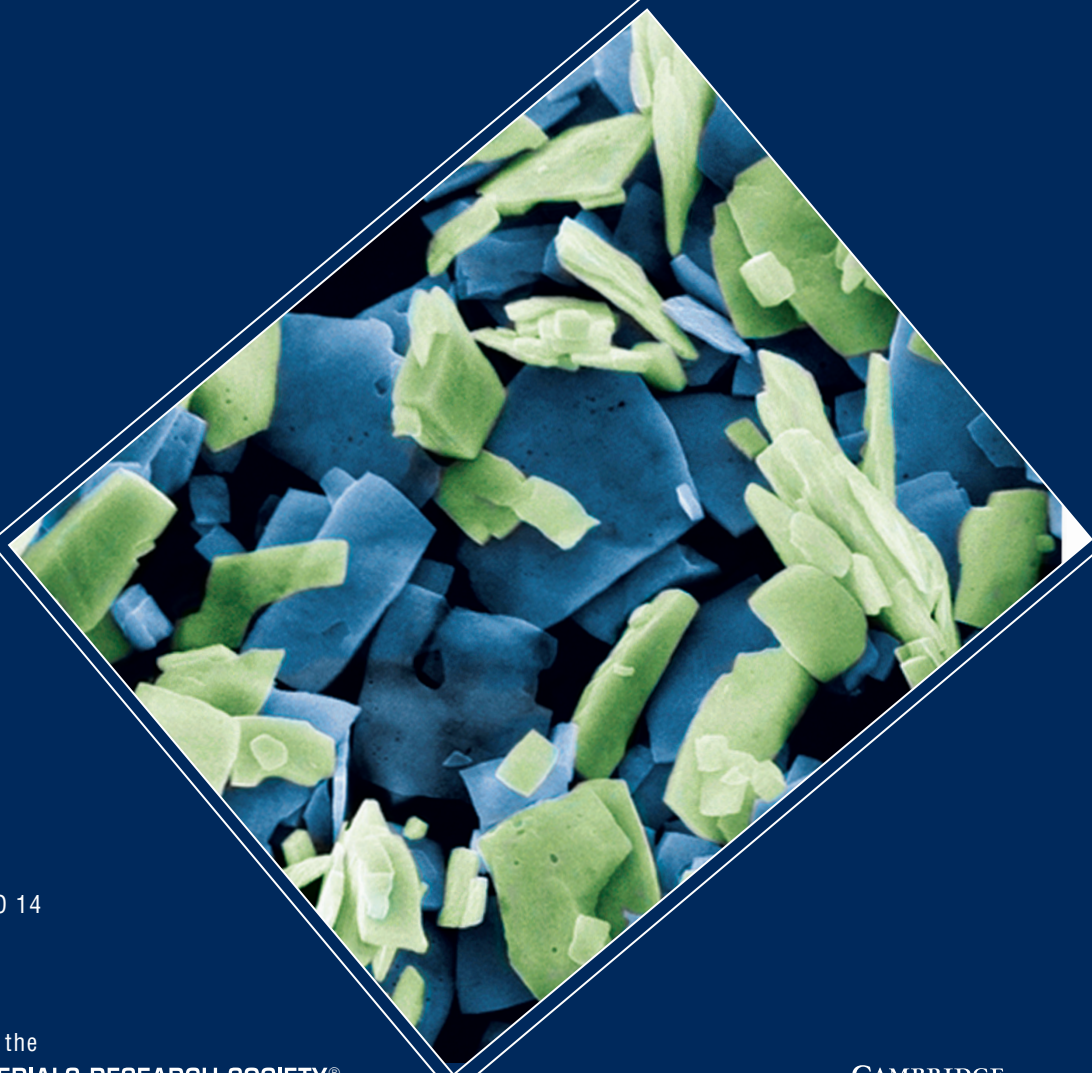


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 **Journal of  
MATERIALS RESEARCH**



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Cover: FIG. 1(b). SEM image of the BT templates. [D-D. Wei, Q-B. Yuan, G.Q. Zhang, H. Wang: Templated Grain Growth and Piezoelectric Properties of (001)-Textured PIN-PMN-PT Ceramics. p. 2144]

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